WIMA SMD-PET

Metallized Polyester (PET)
SMD Film Capacitors with Box Encapsulation

Special Features

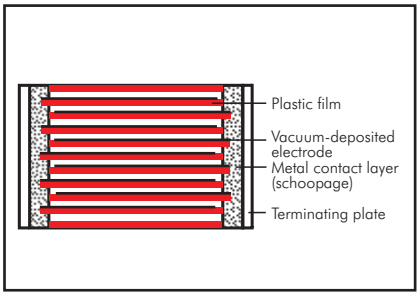
- **Size codes 1812, 2220, 2824, 4030, 5040 and 6054 with PET and encapsulated**
- **Operating temperature up to 100° C**
- **Self-healing**
- **According to RoHS 2002/95/EC**

Typical Applications

For general DC-applications e.g.
- **By-pass**
- **Blocking**
- **Coupling and decoupling**
- **Timing**

Construction

Dielectric:
Polyethylene-terephthalate (PET) film
Capacitor electrodes:
Vacuum-deposited
Internal construction:



Encapsulation:
Solvent-resistant, flame-retardent plastic case, UL 94 V-0
Terminations:
Tinned plates.
Marking:
Colour: Black.

Electrical Data

Capacitance range:
0.01 µF to 6.8 µF
Rated voltages:
63 VDC, 100 VDC, 250 VDC, 400 VDC, 630 VDC, 1000 VDC
Capacitance tolerances:
±20%, ±10% (±5% available subject to special enquiry)
Operating temperature range:
–55° C to +100° C
Climatic test category:
55/100/21 according to IEC for size codes 1812 to 2824
55/100/56 according to IEC for size codes 4030 to 6054
Insulation resistance at +20° C:

U_r	U_{test}	C ⩽ 0.33 µF	0.33 µF < C ⩽ 6.8 µF
63 VDC 100 VDC	50 V 100 V	⩾ 3.75 x 10^3 MΩ (mean value: 1 x 10^4 MΩ)	⩾ 1250 sec (MΩ x µF) (mean value: 3000 sec)
⩾ 250 VDC	100 V	⩾ 1 x 10^4 MΩ (mean value: 5 x 10^4 MΩ)	⩾ 3000 sec (MΩ x µF) (mean value: 10 000 sec)

Measuring time: 1 min.
Dissipation factors at +20° C: tan δ

at f	C ⩽ 0.1 µF	0.1 µF < C ⩽ 1.0 µF	C > 1.0 µF
1 kHz	⩽ 8 x 10^{-3}	⩽ 8 x 10^{-3}	⩽ 10 x 10^{-3}
10 kHz	⩽ 15 x 10^{-3}	⩽ 15 x 10^{-3}	–
100 kHz	⩽ 30 x 10^{-3}	–	–

Maximum pulse rise time: for pulses equal to the rated voltage

Capacitance µF	Pulse rise time V/µsec max. operation/test					
	63 VDC	100 VDC	250 VDC	400 VDC	630 VDC	1000 VDC
0.01 ... 0.022	30/300	35/350	40/400	35/350	40/400	50/500
0.033 ... 0.068	20/200	20/200	40/400	21/210	25/250	32/320
0.1 ... 0.22	10/100	10/100	12/120	14/140	17/170	–
0.33 ... 0.68	8/80	6/60	9/90	10/100	–	–
1.0 ... 2.2	3.5/35	4/40	7/70	–	–	–
3.3 ... 6.8	3/30	3/30	–	–	–	–

Dip Solder Test/Processing

Resistance to soldering heat:
Test Tb in accordance with DIN IEC 60068-2-20/EN 132 200.
Soldering bath temperature max. 260° C.
Soldering duration max. 5 sec.
Change in capacitance ΔC/C < 5%.
Soldering process:
Wave soldering and re-flow soldering (see temperature/time graphs page 14).

Packing

Available taped and reeled in 12 mm blister pack.

Detailed taping information and graphs at the end of the catalogue.

For further details and graphs please refer to Technical Information.

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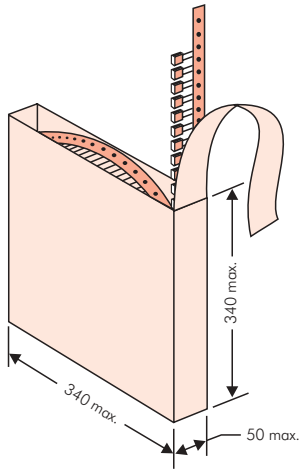
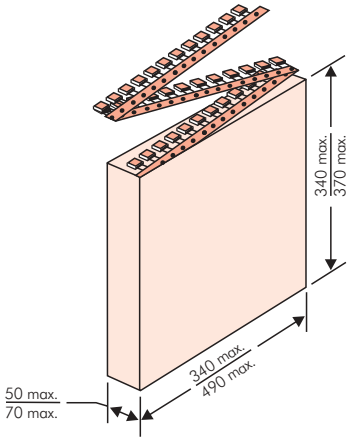
Types of Tape Packaging of Capacitors for Automatic Radial Insertion

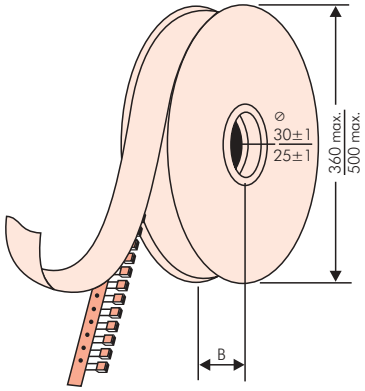
ROLL Packaging



AMMO Packaging



REEL Packaging



BAR CODE (Labelling)

Labelling of package units in plain text and with alphanumerical Bar Code

Scanner decoding of

- WIMA supplier number
- Customer's P/O number
- Customer's part number
- WIMA description
  - article
  - capacitance value
  - capacitance tolerance
  - rated voltage
  - dimensions
- WIMA acknowledgement number
- Quantity

In addition date of delivery and customer's name in plain text.

BARCODE „Code 39"

Example for Ordering WIMA Capacitors

Unlike other manufacturers WIMA does not use special part numbers. In general, the indication of the type together with the electrical values capacitance, tolerance and voltage are sufficient. PCM and taping mode may be necessary.

For example, to order a WIMA MKS 2 (which is only available in PCM 5 mm), capacitance 0.1 µF, 63 VDC, tolerance 20 %, taped in ROLL packaging, taping height 18.5 mm the following is required

MKS 2 0.1/20/63 ROLL 18.5.

Orders and deliveries are subject to our actual Terms of Delivery and Payment.

Please find below some examples:

Family	PCM/Size Code	Value	Taping (optional)
SMD-PEN	2220*	0.1/20/100 VDC	BP 330* (BP = blister pack)
MKS 2		0.1/20/ 63 VDC	ROLL 18.5*
MKS 4	PCM 10*	1.0/10/ 63 VDC	REEL 16.5/360*
MP 3-X2	PCM 15*	0.1/20/250 VAC	

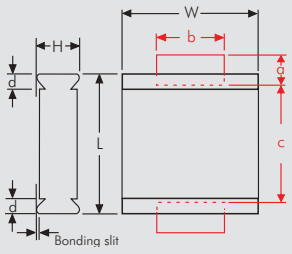
* compare catalogue data

Continuation

General Data

Capacitance	63 VDC/40 VAC*		100 VDC/63 VAC*		250 VDC/160 VAC*		400 VDC/200 VAC*		630 VDC/300 VAC*		1000 VDC/400 VAC*	
	Size code	H ± 0.3	Size code	H ± 0.3	Size code	H ± 0.3	Size code	H ± 0.3	Size code	H ± 0.3	Size code	H ± 0.3
0.01 µF	1812	3.0	1812	3.0	1812	4.0	2824	3.0	4030	5.0	5040	6.0
	2220	3.5	2220	3.5	2220	3.5	4030	5.0				
	2824	3.0	2824	3.0	2824	3.0						
0.015 „	1812	3.0	1812	3.0	1812	4.0	2824	3.0	4030	5.0	5040	6.0
	2220	3.5	2220	3.5	2220	3.5	4030	5.0				
	2824	3.0	2824	3.0	2824	3.0						
0.022 „	1812	3.0	1812	3.0	1812	4.0	2824	5.0	5040	6.0	5040	6.0
	2220	3.5	2220	3.5	2220	3.5	4030	5.0				
	2824	3.0	2824	3.0	2824	3.0						
0.033 „	1812	3.0	1812	3.0	2220	3.5	2824	5.0	5040	6.0	5040	6.0
	2220	3.5	2220	3.5	2824	3.0	4030	5.0				
	2824	3.0	2824	3.0	4030	5.0						
0.047 „	1812	3.0	1812	3.0	2220	3.5	2824	5.0	5040	6.0	6054	7.0
	2220	3.5	2220	3.5	2824	3.0	4030	5.0				
	2824	3.0	2824	3.0	4030	5.0						
0.068 „	1812	3.0	1812	3.0	2220	3.5	4030	5.0	5040	6.0		
	2220	3.5	2220	3.5	2824	3.0	5040	6.0				
	2824	3.0	2824	3.0	4030	5.0						
0.1 µF	1812	3.0	1812	3.0	2220	3.5	4030	5.0	6054	7.0		
	2220	3.5	2220	3.5	2824	5.0	5040	6.0				
	2824	3.0	2824	3.0	4030	5.0						
0.15 „	1812	3.0	1812	4.0	2220	4.5	4030	5.0	6054	7.0		
	2220	3.5	2220	3.5	2824	5.0	5040	6.0				
	2824	3.0	2824	3.0	4030	5.0						
0.22 „	1812	3.0	1812	4.0	2220	4.5	5040	6.0	6054	7.0		
	2220	3.5	2220	3.5	2824	5.0						
	2824	3.0	2824	3.0	4030	5.0						
0.33 „	1812	4.0	2220	4.5	2824	5.0	5040	6.0				
	2220	3.5	2824	5.0	4030	5.0						
	2824	3.0	4030	5.0	5040	6.0						
0.47 „	1812	4.0	2220	4.5	4030	5.0	6054	7.0				
	2220	3.5	2824	5.0	5040	6.0						
	2824	3.0	4030	5.0								
0.68 „	2220	4.5	2824	5.0	5040	6.0						
	2824	3.0	4030	5.0								
	4030	5.0	5040	6.0								
1.0 µF	2220	4.5	2824	5.0	6054	7.0						
	2824	3.0	4030	5.0								
	4030	5.0	5040	6.0								
1.5 „	2824	5.0	4030	5.0								
	4030	5.0	5040	6.0								
2.2 „	2824	5.0	5040	6.0								
	4030	5.0										
3.3 „	4030	5.0	5040	6.0								
4.7 „	5040	6.0	6054	7.0								
6.8 „	6054	7.0										

Solder pad recommendation



Size code	L ±0.3	W ±0.3	d	a min.	b min.	c max.
1812	4.8	3.3	0.5	1.2	3.5	3.5
2220	5.7	5.1	0.5	1.2	4	4.5
2824	7.2	6.1	0.5	1.2	4	6.5
4030	10.2	7.6	0.5	2.5	6	9
5040	12.7	10.2	0.7	2.5	6	11.5
6054	15.3	13.7	0.7	2.5	6	14

* AC voltage: f = 50 Hz; 1.4 x U_{rms} + UDC ⩽ U_r

Dims. in mm.

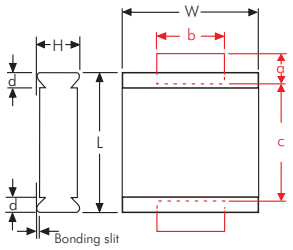
Taped version see page 103.

Recommendation for Processing and Application of SMD Capacitors

Layout Form

The components can generally be positioned on the carrier material as desired. In order to prevent soldering shadows or ensure regular temperature distribution, extreme concentration of the components should be avoided. In practice, it has proven best to keep a minimum distance of the soldering surfaces between two WIMA SMDs of twice the height of the components.

Solder Pad Recommendation



Size code	L ± 0.3	W ± 0.3	d	a min.	b min.	c max.
1812	4.8	3.3	0.5	1.2	3.5	3.5
2220	5.7	5.1	0.5	1.2	4	4.5
2824	7.2	6.1	0.5	1.2	4	6.5
4030	10.2	7.6	0.5	2.5	6	9
5040	12.7	10.2	0.7	2.5	6	11.5
6054	15.3	13.7	0.7	2.5	6	14

The solder pad size recommendations given for each individual series are to be understood as minimum dimensions which can at any time be adjusted to the layout form.

Processing

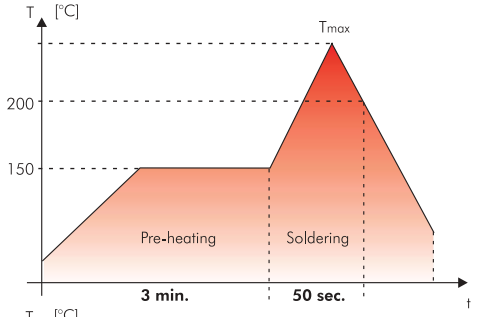
The processing of SMD components

– assembling
– soldering
– washing
– electrical final inspection/ calibrating

must be regarded as a complete process. The soldering of the printed circuit board, for example, can constitute considerable stress on all the electronic components. The manufacturer's instructions on the processing of the components are mandatory.

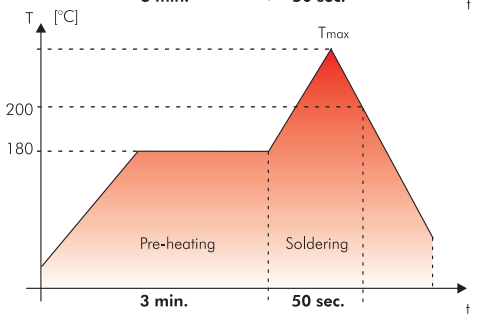
Soldering Process

Re-flow soldering



SMD-PET

Size code	Tmax.
1812	220° C
2220	230° C
2824	230° C
4030	230° C
5040	240° C
6054	250° C



SMD-PEN

Size code	Tmax.
1812	220° C
2220	230° C
2824	230° C
4030	230° C
5040	240° C
6054	250° C

SMD-PPS

Size code	Tmax.
1812	250° C
2220	250° C
2824	250° C

Temperature/time graph for the permissible processing temperature of the WIMA SMD film capacitor for typical convection soldering processes.

Due to the diverse procedures and the varying heat requirements of the different types of components, an exact processing temperature for re-flow soldering processes cannot be specified. The graph shows the upper limits of temperature and time which must not be exceeded when establishing the solder profile according to your actual requirements.
A max. temperature of T = 210° C inside the component should not be exceeded when processing WIMA SMD capacitors.

SMD Handsoldering

WIMA SMD capacitors with plastic film dielectric are generally suitable for hand-soldering with a soldering iron where, however, similar to automated soldering processes, a certain duration and temperature should not be exceeded. These parameters are dependent on the physical size of the components and the relevant heat absorption involved.

The below data are to be regarded as guideline values and should serve to avoid damage to the dielectric caused by excessive heat during the soldering process. The soldering quality depends on the tool used and on the skill and experience of the person with the soldering iron in hand.

Size code	Temperature °C / °F	Time duration
1812	225 / 437	2 sec plate 1 / 5 sec off / 2 sec plate 2
2220	225 / 437	3 sec plate 1 / 5 sec off / 3 sec plate 2
2824	250 / 482	3 sec plate 1 / 5 sec off / 3 sec plate 2
4030	260 / 500	5 sec plate 1 / 5 sec off / 5 sec plate 2
5040	260 / 500	5 sec plate 1 / 5 sec off / 5 sec plate 2
6054	260 / 500	5 sec plate 1 / 5 sec off / 5 sec plate 2

Solder Paste

To obtain the best soldering performance we suggest the use of following solder paste alloy:

Lead free solder paste
Sn - Bi
Sn - Zn (Bi)
Sn - Ag - Cu (recommended)

Solder paste with lead
Sn - Pb - Ag (Sn60-Pb40-A, Sn63-Pb37-A)

Washing

Basically, all plastic encapsuled components, irrespective of the brand cannot be considered as being hermetically sealed. They are therefore only suitable for industrial washing processes to a limited extent. During the washing process, washing agents can penetrate the interior of the component by capillary action through microcracks which might have occured. This is dependent on a number of parameters e.g

- **washing agents**
- **viscosity of the washing solvent**
- **temperature/time of the washing process**
- **mechanical washing aids such as ultrasonic**
  water pressure
  rinsing and spraying pressure

The type of washing agent to be used is largely specific to the individual user or is often laid down by the manufacturer of the washing equipment. The agressiveness of the washing agent to be used can thus only be judged in appropriate test series relating to each individual washing process. By and large, the basic rule is that the washing process should be carried out as gently as possible.

Drying

During the washing process, aqueous solutions can penetrate the component. This can lead to changes in the electrical parameters. Suitable drying measures should ensure that no residual moisture or traces of washing substances are left in the component.

Initial Operation/Calibration

Due to the stress which the components are subjected to during processing, reversible parameter changes occur in almost all electronic components. The capacitance recovery accuracy to be expected with careful processing is within a scope of

$|\Delta C/C| \leq 5\ \%$.

For the initial operation of the device a minimum storage time of

$t \geq 24$ hours

is to be taken into account. With calibrated devices or when the application is largely dependent on capacitance it is advisable to prolong the storage time to

$t \geq 10$ days

In this way ageing effects of the capacitor structure can be anticipated. Parameter changes due to processing are not to be expected after this period of time

Humidity Protection Bags

Taped WIMA SMD capacitors are shipped in humidity protection bags according to JEDEC standard, level 1 (EMI/static-shielding bags conforming to MIL-B 81705, Type 1, Class 1). Under controlled conditions the components can be stored two years and more in the originally sealed bag. Opened packing units should be consumed instantly or resealed for specific storage under controlled conditions.

Reliability

Taking account of the manufacturer's guidelines and compatible processing, the WIMA SMD stand out for the same high quality and reliability as the analogous through-hole WIMA series. The technology of metallized film capacitors used e.g. in WIMA SMD-PET achieves the best values for all fields of application. The expected value is about:

$\lambda_0 \leq 2$ fit

Furthermore the production of all WIMA components is subject to the regulations laid down by ISO 9001:2000 as well as the guidelines for component specifications set out by IEC quality assessment system (IECQ-CECC) for electronic components.

Electrical Characteristics and Fields of Application

Basically the WIMA SMD series have the same electrical characteristics as the analogous through-hole WIMA capacitors. Compared to ceramic or tantalum dielectrics WIMA SMD capacitors have a number of other outstanding qualities :

- **favourable pulse rise time**
- **low ESR**
- **low dielectric absorption**
- **available in high voltage series**
- **large capacitance spectrum**
- **stand up to high mechanical stress**
- **good long-term stability**

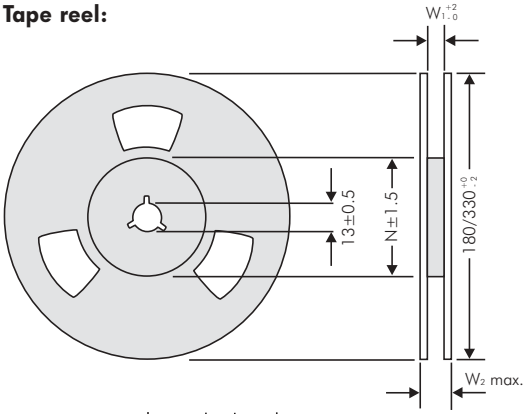
As regards technical performance as well as quality and reliability, the WIMA SMD series offer the possibility to cover nearly all applications of conventionally through-hole film capacitors with SMD components. Furthermore, the WIMA SMD series can now be used for all the demanding capacitor applications for which, in the past, the use of through-hole components was mandatory:

- **measuring techniques**
- **oscillator circuits**
- **differentiating and integrating circuits**
- **A/D or D/A transformers**
- **sample and hold circuits**
- **automotive electronics**

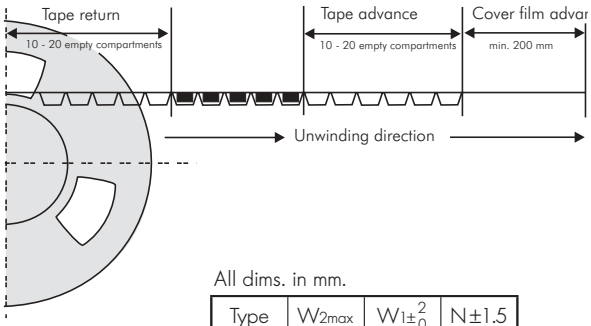
With the WIMA SMD programme available today, the major part of all plastic film capacitors can be replaced by WIMA SMD components. The field of application ranges from standard coupling capacitors to use in switch-mode power supplies as filter or charging capacitors with high voltage and capacitance values, as well as in telecommunications e.g. the well-known telephone capacitor 1µF/250VDC.

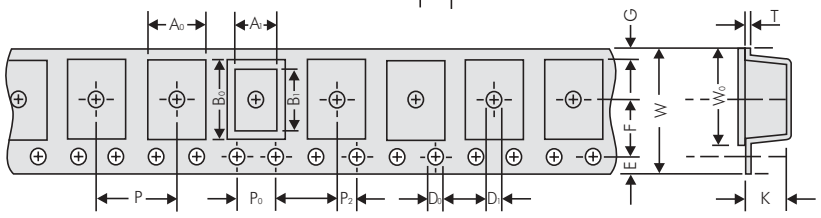
Blister Tape Packaging and Packing Units of the WIMA SMD Capacitors

Tape reel:



Tape advance and return:





All dims. in mm.

Type	W2max	W1±2 0	N±1.5
1812	19	12.4	62
2220	19	12.4	62
2824	19	12.4	62
4030	22.4	16.4	60
5040	30.4	24.4	90
6054	30.4	24.4	90

Packing units

SMD 1812 Box size	A0 ±0.1	A1	B0 ±0.1	B1	D0 +0.1 -0	D1 +0.1 -0	P ±0.1	P0* ±0.1	P2 ±0.05	E ±0.1	F ±0.05	G	W ±0.3	W0 ±0.2	K ±0.1	T ±0.1	taped Reel 180 mm ø	taped Reel 330 mm ø	bulk
4.8x 3.3x 3	3.55	3.3	5.1	4.8	ø1.5	ø1.5	8	4	2	1.75	5.5	2.2	12	9.5	3.4	0.3	750	2500	1000
4.8x 3.3x 4	3.55	3.3	5.1	4.8	ø1.5	ø1.5	8	4	2	1.75	5.5	2.2	12	9.5	4.4	0.3	500	2000	1000

SMD 2220 Box size	A0 ±0.1	A1	B0 ±0.1	B1	D0 +0.1 -0	D1 +0.1 -0	P ±0.1	P0* ±0.1	P2 ±0.05	E ±0.1	F ±0.05	G	W ±0.3	W0 ±0.2	K ±0.1	T ±0.1	taped Reel 180 mm ø	taped Reel 330 mm ø	bulk
5.7x 5.1x 3.5	6.3	5.7	5.6	5.1	ø1.5	ø1.5	8	4	2	1.75	5.5	1.95	12	9.5	3.7	0.3	500	1800	1000
5.7x 5.1x 4.5	6.3	5.7	5.6	5.1	ø1.5	ø1.5	8	4	2	1.75	5.5	1.95	12	9.5	4.7	0.3	400	1500	1000

SMD 2824 Box size	A0 ±0.1	A1	B0 ±0.1	B1	D0 +0.1 -0	D1 +0.1 -0	P ±0.1	P0* ±0.1	P2 ±0.05	E ±0.1	F ±0.05	G	W ±0.3	W0 ±0.2	K ±0.1	T ±0.1	taped Reel 330 mm ø	bulk
7.2x 6.1x 3	6.6	6.1	7.7	7.2	ø1.5	ø1.5	12	4	2	1.75	5.5	0.9	12	9.5	3.4	0.3	1500	1000
7.2x 6.1x 5	6.6	6.1	7.7	7.2	ø1.5	ø1.5	12	4	2	1.75	5.5	0.9	12	9.5	5.4	0.4	750	1000

	A0 ±0.1	A1	B0 ±0.1	B1	D0 +0.1 -0	D1 +0.1 -0	P ±0.1	P0* ±0.1	P2 ±0.05	E ±0.1	F ±0.05	G	W ±0.3	W0 ±0.2	K ±0.1	T ±0.1	taped Reel 330 mm ø	bulk
SMD 4030	10.7	10.2	9.7	9.1	ø1.5	ø1.5	16	4	2	1.75	7.5	1.9	16	13.3	5.9	0.3	775	500
SMD 5040	13.2	12.7	12.1	11.5	ø1.5	ø1.5	16	4	2	1.75	11.5	4.7	24	21.3	7.0	0.3	775	500
SMD 6054	17.0	16.5	15.6	15.0	ø1.5	ø1.5	20	4	2	1.75	11.5	2.95	24	21.3	7.5	0.3	600	200

* cumulative after 10 steps ± 0.2 mm max.
Samples and pre-production needs on request or 1 Reel minimum.